503790499 04/19/2016

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
MING YUE	03/15/2016
WEIQIANG LIU	03/15/2016
XIANTAO LI	03/15/2016
MENG LI	03/15/2016
MIN LIU	03/15/2016
DONGTAO ZHANG	03/15/2016
XIAOWEN YIN	03/15/2016
XIULIAN HUANG	03/15/2016
JINGWU CHEN	03/15/2016
XIAOFEI YI	03/15/2016

#### **RECEIVING PARTY DATA**

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Postal Code:	100124
Name:	ANHUI EARTH-PANDA ADVANCE MAGNETIC MATERIAL CO., LTD.
Street Address:	ANHUI PROVINCE ECONOMIC DEVELOPMENT ZONE
City:	LUJIANG COUNTY
State/Country:	CHINA
Postal Code:	231500

### **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	15133042	

### **CORRESPONDENCE DATA**

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> **PATENT** REEL: 038323 FRAME: 0531

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ATTORNEY DOCKET NUMBER:	SHTD2023	
NAME OF SUBMITTER:	JIAWEI HUANG	
SIGNATURE:	/JIAWEI HUANG/	
DATE SIGNED:	04/19/2016	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

**Total Attachments: 3** 

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PATENT REEL: 038323 FRAME: 0532 Docket No.: SHTD2023 **US PATENT** 

# COMBINED DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

WHEREAS, the undersigned has invented certain new and useful improvements as described and set forth in the below identified application for United States Patent:

Title

A Short Process Preparation Technology of Sintered NdFeB of the Invention: Magnets with High Magnetic Properties Recycling from NdFeB Sludge [X] The attached application, or [ ] United States application or PCT application number \_\_\_\_\_\_ filed on and as amended under PCT Article 19 on \_\_\_\_\_ (if applicable). The above-identified application was made or authorized to be made by me. I believe that I am the original inventor or an original joint inventor of a claimed invention in the application. (1) BEIJING UNIVERSITY OF TECHNOLOGY (hereinafter termed "Assignee"), WHEREAS, a China university (2) ANHUI EARTH-PANDA ADVANCE MAGNETIC MATERIAL CO., LTD. (hereinafter termed "Assignee"), a China corporation residing at (1) NO. 100 PINGLEYUAN, CHAOYANG DISTRICT, BEIJING 100124, **CHINA** (2) LUJIANG COUNTY, ANHUI PROVINCE ECONOMIC DEVELOPMENT

is desirous of acquiring the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or disclosed jointly or severally by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, certificates of invention and other forms of protection thereon (hereinafter termed "patents") applied for or granted in the United States and/or other countries.

**ZONE, 231500, CHINA** 

NOW THEREFORE, for good and valuable consideration acknowledged by each of said Inventors to have been received in full from said Assignee:

1. Said Inventors do hereby sell, assign, transfer and convey to said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply in any or all countries of the world for patents, certificates of inventions or other governmental grants on said invention, including the right to apply for patents pursuant to the International Convention for the Protection of Industrial Property or pursuant to any other convention, treaty, agreement or understanding; (c) in and to any and all applications filed and any and all patents, certificates of inventions or other governmental grants granted on said invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; (d) in and to each and every reissue or extension of any of said patents; and (e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.

### COMBINED DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION CONTINUED

2. Said Inventors hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and other countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, executing of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for complying with any duty of disclosure; (c) for prosecuting any of said applications; (d) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (e) for filing and prosecuting applications for reissue of any of said patents; (f) for interference or other priority proceedings involving said invention; and (g) for legal proceedings involving said invention and any applications therefor and any patents granted

thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, reexamination proceedings, compulsory licensing proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

- 3. The terms and covenants of this Assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, their respective heirs, legal representatives and assigns.
- 4. Said Inventors hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful, false statements may jeopardize the validity of the application or any patent issued thereon.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

## **LEGAL NAME OF INVENTOR:**

Full name of the sole or first inventor: YUE, Ming				
Inventor's signature: 1 Ciz ve Da	ate:	mon.	15,	2016
	-			
[ X ] Additional inventors or a legal representative are being nar sheet(s) attached hereto	med (	on the 1	suppl	emental

### COMBINED DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION ADDITIONAL INVENTOR(S) Supplemental Sheet

Name of Additional Joint Inventor: LIU, Weigiang	
Inventor's signature: Lin Weigiang	Date: Mar. 15. 2016
Name of Addisonal States	
Name of Additional Joint Inventor: LI, Xiantao	
Inventor's signature: Li, Xiantov	Date:
Name of Additional Joint Inventor: LI, Meng	
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Inventor's signature: Li Mong	_ Date: Mor. 15, w/b
Name of Additional Joint Inventor: LIU, Min	
•	
Inventor's signature: Liu Min	Date:Molf . 15 . 20 16
Name of Additional Joint Inventor: ZHANG, Dongtao	
Inventor's signature: Zhang Dongtao	Date:Mov, 15, 2016
Name of Additional Joint Inventor: YIN, Xiaowen	
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Inventor's signature: Yin Xiwwen	Date: Mar. 15. 2016
Name of Additional Joint Inventor: HUANG, Xiulian	
Inventor's signature: Huang Yiulian	_ Date: May. 15. 2011
Name of Additional Joint Inventor: CHEN, Jingwu	
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Inventor's signature: Chen Juynov	_ Date: May 15. 2016
Name of Additional Lains Land	
Name of Additional Joint Inventor: VI, Xiaofei	1
Inventor's signature: Yr. Ninotei	Date: Mal. 15. 2016